

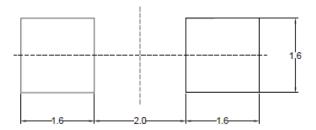
# SPECIFICATIONS CS126AW2C

# Cathode Mark Resin 0.5 Soldering Terminal

### Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ±0.1mm unless otherwise noted.

# **Recommended Solder Pad**



Note: The tolerances unless mentioned is ±0.1mm,Angle±0.5. Unit=mm.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CS126AW2C	InGaN/GaN	White	Yellow Diffused	160°	





# **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Value	Unit	
Forward current	If	20	mA	
Reverse current @ 5V	Ir	50	μΑ	
Power dissipation	Pd	80	mW	
Operating temperature range	Topr	-40~+85	°C	
Storage temperature range	Tstg	-40~+90	°C	
Peak pulsing current (1/10 duty f= 10KHz)	lfp	100	mA	
Soldering Temperature	T <sub>SOL</sub>	Max 260°C for 5 sec Max		

# **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

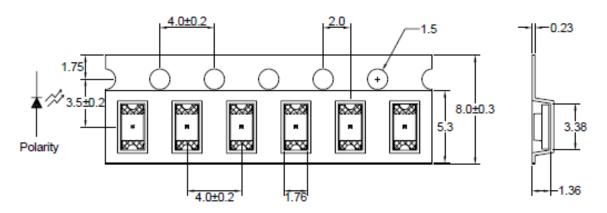
December	0	T1 0177	Value			11.2	
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Chromaticity Coordinates	X	I <sub>F</sub> = 20mA	0.21	ı	0.35		
Chromaticity Coordinates	Y	I <sub>F</sub> = 20mA	.015	ı	0.4		
Spectral half bandwidth	Δλ	I <sub>F</sub> = 20mA	-	30	-	nm	
Forward Voltage	Vf	I <sub>F</sub> = 20mA	-	3.5	4.0	V	
Luminous intensity	lv	I <sub>F</sub> = 20mA	125	320	-	mcd	
Viewing angle at 50% lv	20 ½	I <sub>F</sub> = 20mA	-	160		Deg	

<sup>\*</sup>NOTE: 1. The forward voltage data did not including ±0.1V tolerance 2. The luminous intensity data did not including ±15% tolerance



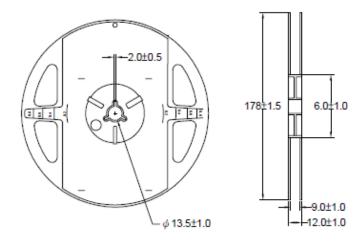


# **DIMENSIONS OF TAPE (Unit: mm)**



NOTE: The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5$ . Unit = mm.

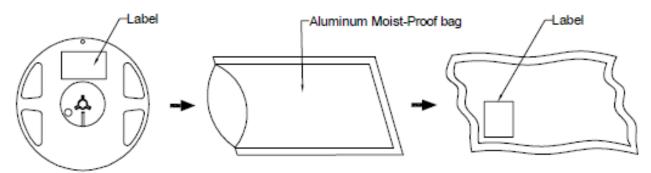
# **REEL DIMENSIONS**



### NOTES:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 3,000pcs/Reel

# PACKAGING SPECIFICATION







# **OPTICAL CHARACTERISTIC CURVES**

Fig.1 Forward current vs. Forward Voltage

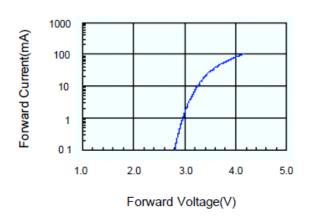


Fig.3 Forward Voltage vs. Temperature

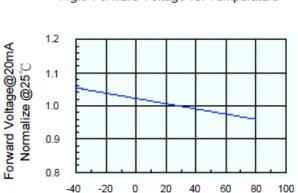


Fig.5 Luminous Spectrum(Ta=25°℃)

Ambient Temperature(°C)

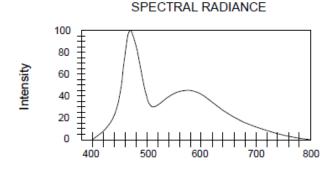


Fig.2 Relative Intensity vs. Forward Current

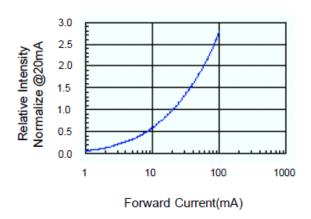


Fig.4 Relative Intensity vs. Temperature

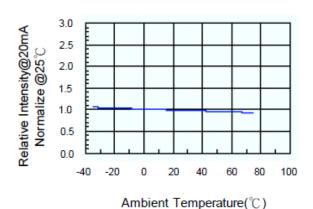
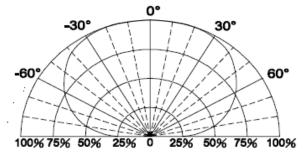


Fig.6 Directive Radiation





# **CHROMATICITY COORDINATES SPECIFICATIONS FOR BIN GRADING**

BIN	х	Y	BIN	х	Y	BIN	х	Y
A1	0.21	0.190	B1	0.26	0.265	C1	0.31	0.340
	0.21	0.150		0.26	0.225		0.31	0.300
	0.22	0.165		0.27	0.240		0.32	0.315
	0.22	0.205		0.27	0.280		0.32	0.355
	0.22	0.205	B2	0.27	0.280	C2	0.32	0.355
A2	0.22	0.165		0.27	0.240		0.32	0.315
	0.23	0.180		0.28	0.255		0.33	0.330
	0.23	0.220		0.28	0.295		0.33	0.370
А3	0.23	0.220	B3	0.28	0.295	C3	0.33	0.370
	0.23	0.180		0.28	0.255		0.33	0.330
	0.24	0.195		0.29	0.270		0.34	0.345
	0.24	0.235		0.29	0.310		0.34	0.385
	0.24	0.235	B4	0.29	0.310	C4	0.34	0.385
A4	0.24	0.195		0.29	0.270		0.34	0.345
A4	0.25	0.210		0.30	0.285		0.35	0.360
	0.25	0.250		0.30	0.325		0.35	0.400
<b>A</b> 5	0.25	0.250	B5	0.30	0.325			
	0.25	0.210		0.30	0.285			
	0.26	0.225		0.31	0.300			
	0.26	0.265		0.31	0.340			



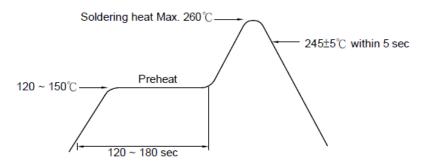


# **SOLDERING CONDITIONS – LAMP TYPE LED**

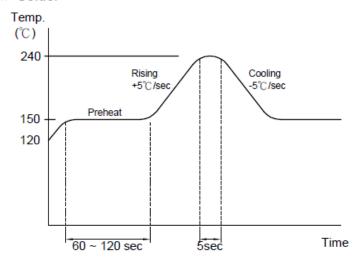
### Hand Solder

Basic spec is  $\leq 280^{\circ}$ C 3 sec one time only.

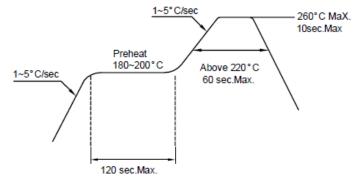
### 2. Wave Solder



### 3-1. LEAD Reflow Solder



## 3-2 PB-Free Reflow Solder



Reflow Soldering should not be done more than two times.

